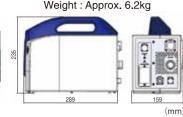
#### Size - Weight





Power Supply Unit Weight: Approx. 6.2kg



17.2%

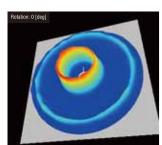
(6.5 - 25.6%)

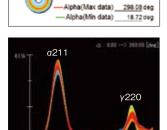
|  | Opcomoditori              |   |
|--|---------------------------|---|
|  |                           |   |
|  | Measurement items         | ①Residual Stress ②FWHM ③Retained austenite (Optional                      |
|  | Measurement method        | Single incident angle X-ray exposure $(\cos lpha)$ method                 |
|  | Collimator size           | Standard: $\phi$ 1.0mm (illumination area at surface Approx. $\phi$ 2.0mm |
|  | X-ray tube cooling method | Air cooling   |
|  |                           |   |

#### **Options**

#### **ORetained austenite**

Measures the percentage of retained austenite not transformed to martensite upon quenching.

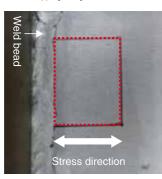


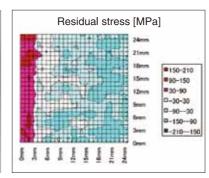


#### Mapping function

Power supply

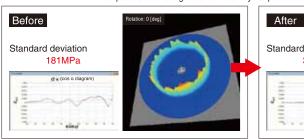
Stress mapping using software controlled XY axis stage for automatic positioning and measurement.





AC 100~240V, 50/60Hz, 130W

Oscillation unit Measurement accuracy improved by controlled sensor unit oscillation; the changing angles of X-ray exposure allows a greater number crystal planes to be sampled.







OX-ray tube exchange

#### Accessories



### Flexible arm

(with fine adjustment stage and magnetic base) Flexible arm to adjust the sensor unit's position. Both X and Y axis are adjustable in 50mm range in steps with 0.01 mm resolution, using a magnetic base.



### Hand-carry case

Watertight and crush-proof case. Urethane foam protects the equipment inside the case

[Example] Main unit, Flexible arm, Safety shielding board, Angle gauge, Size: W630 X D500 X H300mm



#### Safety cabinet

The safety cabinet with interlock protection is designed to protect users from X-ray leakage; less than 0.1 μSv/hour. Size: W800 X D600 X H600mm \*Also available customized cabinets to customers design and size. (Optional)



#### Electrochemical polisher

Localised controlled electrolytic removal of material from the sample's surface without applying additional stress, used with the analysis to produce depth / residual stress

Caution: Use of X-ray product Please follow the local regulations / laws in each country when operating the u-X360.

\*The specification in this document may change without prior notice.



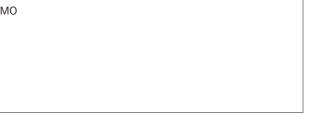
## Pulstec Industrial Co.,Ltd.

7000-35 Nakagawa, Hosoe-cho, Kita-ku, Hamamatsu-city, Shizuoka Pref., 431-1304, JAPAN Tel:+81-53-522-3611 Fax:+81-53-522-5622

U R L: http://www.pulstec.co.jp/ E-mail: sales@pulstec.co.jp



ISO14001(Domestic Office)



# Portable X-ray Residual Stress Analyzer

NEW LL-X360s

The world's lightest and smallest





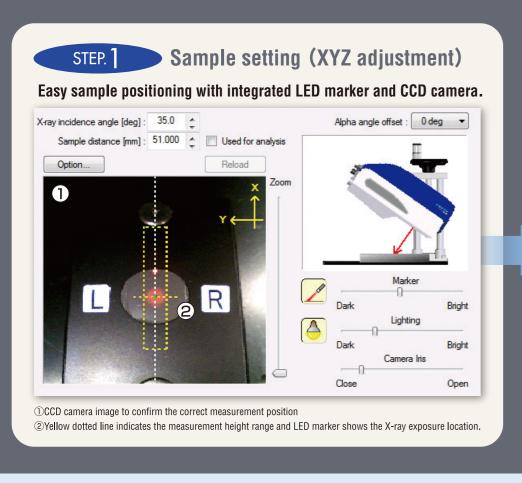
Operability Easy sample setting, measurement time: Approx. 60 secs (Ferritic samples)

Portability Sensor unit: Approx. 2.4kg, Power supply unit: Approx. 6.2kg. Ideally suited for field measurements.

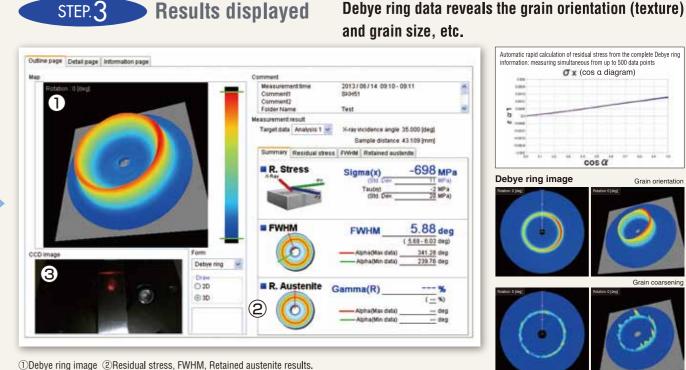
Applications Thermal treatment industrial of products, welding, plastic forming, surface reformation, monitoring and maintenance of plant and infrastructure.

Able to measure in pipes with internal diameters down to 170mm wide.

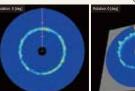


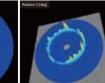


STEP. 7 Measurement start X-ray exposure Data analysis



Automatic rapid calculation of residual stress from the complete Debye ring σx (cos α diagram)





## Indoor laboratory or workshop use

- OInterlocked safety cabinet protects users from radiation leakage.
- ©Easy sample setting using the sensor unit's stand adjustment.



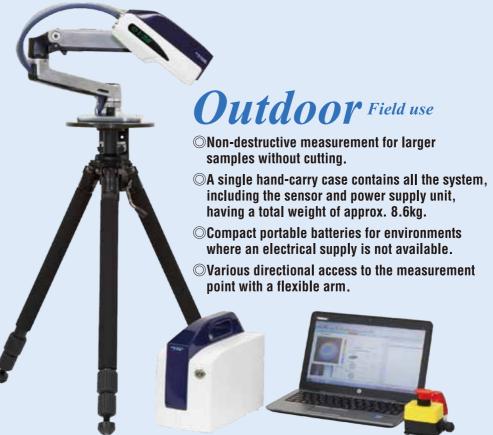






Fillet welds, including HAZ and bead regions





3CCD camera image for quick and easy sample positioning.







Bridges : Monitoring aging effects